

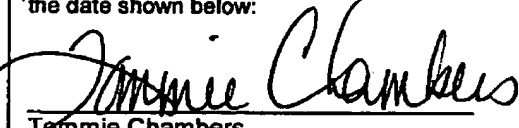
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NAME OF INVENTOR(S): Crenshaw	RECEIPT DATE & SERIAL NO.: Serial No.: 10/642,969 Filing Date: 8/18/2003
TITLE OF INVENTION: MICRO-ELECTROMECHANICAL SWITCH FABRICATED BY SIMULTANEOUS FORMATION OF A RESISTOR AND BOTTOM ELECTRODE	
TI FILE NO.: TI-29906.1	DEPOSIT ACCT. NO.: 20-0668
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